

Key Value

- □ Accelerates UCIE chiplet development
- □ Automates layout-to-compliance workflow
- □ Reduces engineering effort and verification time
- □ Detects signal integrity issues early
- □ Minimizes costly package re-spins
- □ Supports UCIE-A and UCIE-S standards
- □ Integrates extraction, compliance, and simulation
- □ Generates executive-ready reports automatically
- □ Improves design confidence and first-pass success
- □ Enables faster time-to-market